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Curtis L. Schrandt

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS

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APPLICATION NO.

: 10/618,985

FILED

: 07/14/03

FOR

: THERMOPLASTIC MOLDING PROCESS

GROUP ART UNIT

: 1732

EXAMINER: STAICOVICI, Stefan

ATTY DOCKET NO.

: JETTA-003US

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

CHANGE OF CORRESPONDENCE ADDRESS

SIR:

Enclosed herewith please find a Change of Correspondence Address form and Supplemental Application Data Sheet for entry in the above-identified patent application. The contact information has changed, as indicated on the forms. Kindly direct all telephone calls to the undersigned at (203) 366-3560, and faxes to (203) 335-6899.

Respectfully submitted,

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Dated: January 25, 2006

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